# Specification of Thermoelectric Module TES1-04130CH6

# **Description**

The 41 couples, 20mm x 20mm size module is a single stage module which is made of our high performance ingot to achieve superior cooling performance and larger delta Tmax, is designed for superior cooling and heating applications. Beyond the standard below, we can design and manufacture the custom made module according to your special requirements.

### Features

- No moving parts, no noise, and solid-state
- Compact structure, small in size, light in weight
- Environmental friendly
- RoHS compliant
- Precise temperature control
- Exceptionally reliable in quality, high performance

# **Application**

- Food and beverage service refrigerator
- Portable cooler box for cars
- Liquid cooling
- Temperature stabilizer
- CPU cooler and scientific instrument
- Photonic and medical systems

# **Performance Specification Sheet**

Th (°C)	27	50	Hot side temperature at environment: dry air, N <sub>2</sub>
DT <sub>max</sub> (°C)	70	79	Temperature Difference between cold and hot side of the module when cooling capacity is zero at cold side
U <sub>max</sub> (Voltage)	5.06	5.46	Voltage applied to the module at DT <sub>max</sub>
I <sub>max</sub> (Amps)	3.2	3.2	DC current through the modules at DT <sub>max</sub>
Q <sub>Cmax</sub> (Watts)	10.54	11.35	Cooling capacity at cold side of the module under DT=0 °C
AC resistance (Ohms)	1.20	1.29	The module resistance is tested under AC
Tolerance (%)	10%		For thermal and electricity parameters

# Geometric Characteristics Dimensions in millimeters

# 0.03 A 0.02 HOT SIDE A 0.02 HB-0.35 4 600 20 0.02 (+) POSITIVE (-) NEGATIVE

# **Manufacturing Options**

A. Solder:	B. Sealant:
1. T100: BiSn (Tmelt=138°C)	1. NS: No sealing (Standard)
2. T200: CuAgSn (Tmelt = 217°C)	2. SS: Silicone sealant
3. T240: SbSn (Tmelt = 240°C)	3. EPS: Epoxy sealant
C. Ceramics:	D. Ceramics Surface Options:
1. Alumina (Al <sub>2</sub> O <sub>3</sub> , white 96%)	1. Blank ceramics (not metalized)
2. Aluminum Nitride (AlN)	2. Metalized

# **Ordering Option**

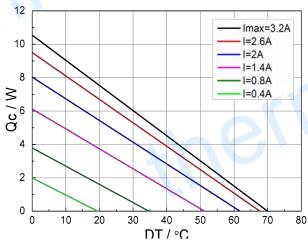
Suffix	Thickness H (mm)	Flatness/ Parallelism (mm)	Lead wire length(mm) Standard/Optional length
TF	0:3.8± 0.10	0: 0.05/0.05	120±3 /Specify
TF	1:3.8± 0.05	1: 0.02/0.03	120±3 /Specify

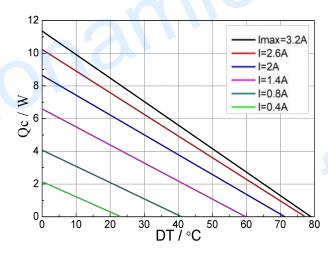
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# **TES1-04130CH6**

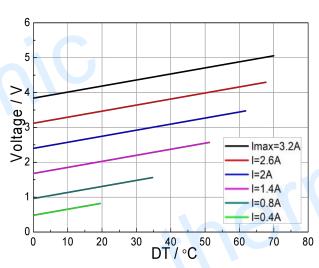
## Performance Curves at Th=27 °C

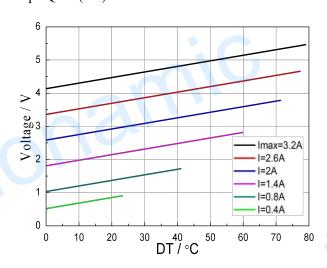
### Performance Curves at Th=50 °C



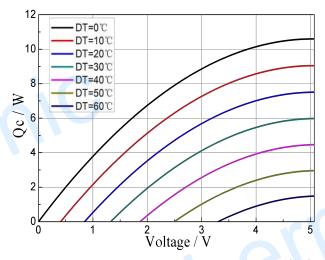


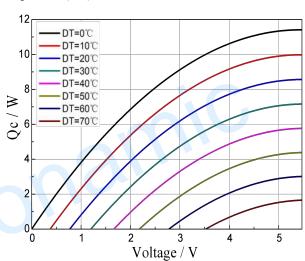
Standard Performance Graph Qc= f(DT)





Standard Performance Graph V = f(DT)



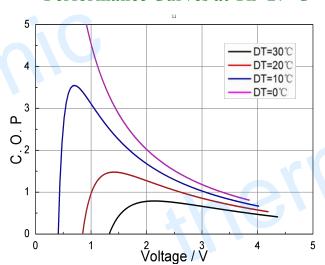


Standard Performance Graph Qc = f(V)

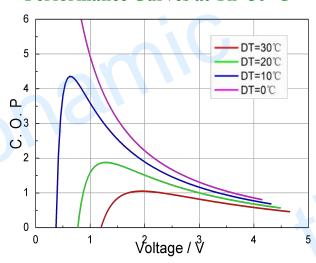
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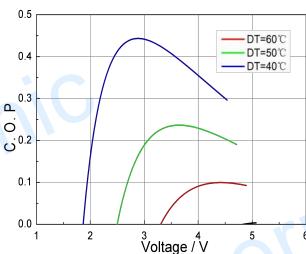


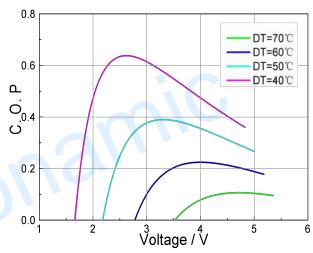


# Performance Curves at Th=50 °C



Standard Performance Graph COP = f(V) of  $\Delta T$  ranged from 0 to 30 °C





Standard Performance Graph COP = f(V) of DT ranged from 40 to 60/70 °C

**Remark:** The coefficient of performance (COP) is the cooling power Qc/Input power ( $V \times I$ ).

# **Operation Caution**

- Cold side of the module sticked on the object being cooled
- Hot side of the module mounted on a heat radiator
- Operation below I<sub>max</sub> or V<sub>max</sub>
- Work under DC

Note: All specifications subject to change without notice.